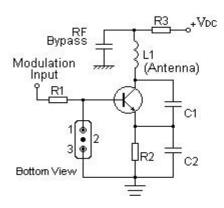
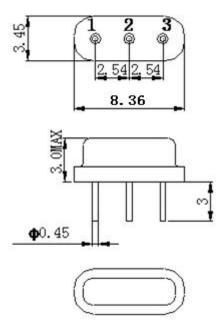
- 1-port Resonator
- Metal Case for **D11**
- Package size 8.36x3.45x3.00 mm³
- RoHS compatible
- Electrostatic Sensitive Device(ESD)

Application

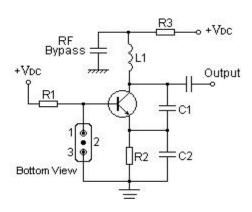
Typical Low-Power Transmitter Application



Package Dimensions (D11)



Typical Local Oscillator Application



Pin Configuration

| 1 | Input/output | | |
|---|--------------|--|--|
| 3 | Output/Input | | |
| 2 | Case Ground | | |

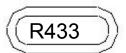
| R | SAW Resonator |
|----|---------------|
| 1. | OAW NESCHALO |



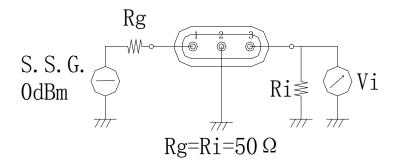
Marking

433

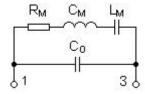
Part number



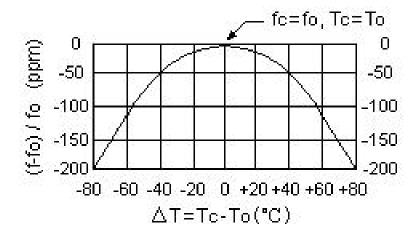
Test Circuit



Equivalent LC Model



Temperature Characteristics



The curve shown above accounts for resonator contribution only and does not include LC component temperature contributions.

Performance

Maximum Rating

| ltem | | Value | Unit |
|-----------------------|------------------|------------|---------------|
| DC Voltage | V _{DC} | ±30 | V |
| Operation Temperature | Т | -40 ~ +85 | $^{\circ}$ |
| Storage Temperature | T _{stg} | -55 ~ +125 | ${\mathbb C}$ |
| RF Power Dissipation | Р | 10 | dBm |

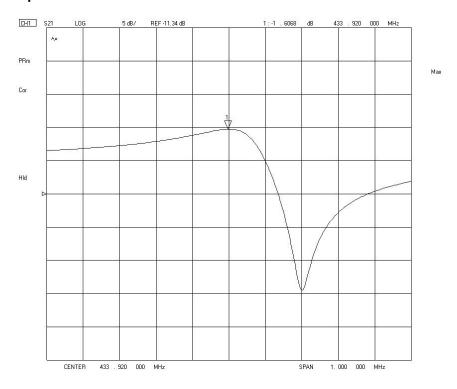
Electronic Characteristics

Test Temperature: $25^{\circ}C \pm 2^{\circ}C$

Terminating source impedance: 50Ω Terminating load impedance: 50Ω

| | ltem | | Minimum | Typical | Maximum | Unit |
|--------------------------|-----------------------------------|----------------|---------|----------------|---------|--------------|
| Center | Absolute Frequency | fc | | 433.92 | | MHz |
| Frequency | Tolerance from 433.92MHz | △fc | | ±75 | | KHz |
| Insertion Loss(min) | | IL | | 1.4 | 2.0 | dB |
| Quality Factor | Unloaded Q | Q _U | | 14215 | | |
| Quality Factor | 50Ω Loaded Q | Q _L | | 1791 | | |
| | Turnover Temperature | T ₀ | 10 | 25 | 40 | $^{\circ}$ C |
| Temperature Stability | Turnover Frequency | f ₀ | | f _c | | KHz |
| | Frequency Temperature Coefficient | FTC | | 0.032 | | ppm/℃ |
| Frequency Aging | | | | ≤10 | | ppm/yr |
| DC Insulation R | esistance between Any Two Pins | | 1.0 | | | МΩ |
| RF Equivalent | Motional Resistance | R _M | | 15 | 26 | Ω |
| | Motional Inductance | L _M | | 98.9 | | μН |
| RLC Model | Motional Capacitance | См | | 2.35 | | fF |
| Static Capacitance | | C ₀ | 2.8 | 3.1 | 3.4 | pF |

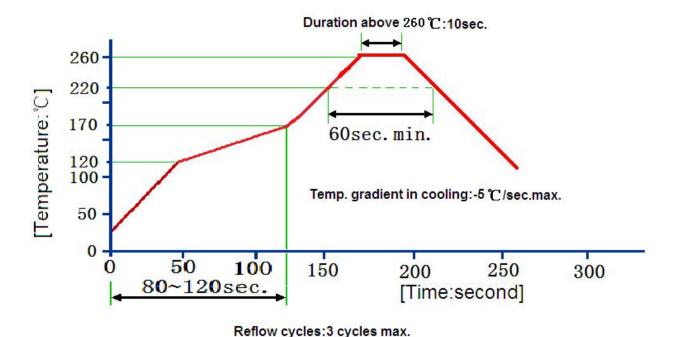
Frequency Response



Reliability (The SAW components shall remain electrical performance after tests)

| No. | Test item | Test condition |
|-----|---------------------------------|--|
| 1 | Temperature Storage | (1) Temperature: 85℃±2℃, Duration: 250h, Recovery time: 2h±0.5h (2) Temperature: -40℃±3℃, Duration: 250h, Recovery time: 2h±0.5h |
| 2 | Humidity Test | Conditions: 60°C±2°C , 90~95% RH Duration: 250h |
| 3 | Thermal Shock | Heat cycle conditions: TA=-40°C±3°C, TB=85°C±2°C, t1=t2=30min, Switch time: ≤3min , Cycle time: 100 times , Recovery time : 2h±0.5h. |
| 4 | Vibration Fatigue | Frequency of vibration: 10~55Hz Amplitude:1.5mm Directions: X,Y and Z Duration: 2h |
| 5 | Drop Test | Cycle time: 10 times Height: 1.0m |
| 6 | Solder Ability Test | Temperature: 245°C±5°C Duration: 3.0s5.0s Depth: DIP2/3 , SMD1/5 |
| 7 | Resistance to Soldering Heat | (1)Thickness of PCB:1mm , Solder condition: 260 ℃ ±5 ℃ , Duration: 10±1s (2)Temperature of Soldering Iron: 350 ℃ ±10 ℃ , Duration: 3~4s , Recovery time : 2 ± 0.5h |

Recommended Reflow Soldering Diagram



Notes

- 1. As a result of the particularity of inner structure of SAW products, it easy to be breakdown by electrostatic, so we should pay attention to **ESD protect** in the test.
- 2. **Static voltage** between signal load and ground may cause deterioration and destruction of the component. Please avoid static voltage.
- 3. **Ultrasonic cleaning** may cause deterioration and destruction of the component. Please avoid ultrasonic cleaning.
- 4. Only leads of component may **be soldered**. Please avoid soldering another part of component.
- 5. There is a close relationship between the device's performance and **matching network**. The specifications of this device are based on the test circuit shown above. L and C values may change depending on board layout. Values shown are intended as a guide only.